



PMEG6020ER

2 A low V_F MEGA Schottky barrier rectifier

Rev. 01 — 3 March 2010

Product data sheet

1. Product profile

1.1 General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a SOD123W small and flat lead Surface-Mounted Device (SMD) plastic package.

1.2 Features and benefits

- Average forward current: $I_{F(AV)} \leq 2$ A
- Reverse voltage: $V_R \leq 60$ V
- Low forward voltage
- High power capability due to clip-bond technology
- AEC-Q101 qualified
- Small and flat lead SMD plastic package

1.3 Applications

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch Mode Power Supply (SMPS)
- Reverse polarity protection
- Low power consumption applications

1.4 Quick reference data



Table 1. Quick reference data
 $T_j = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit	
$I_{F(AV)}$	average forward current	square wave; $\delta = 0.5$; $f = 20$ kHz					
		$T_{amb} \leq 75$ °C	[1]	-	-	2	A
		$T_{sp} \leq 135$ °C	-	-	-	2	A
V_R	reverse voltage		-	-	60	V	
V_F	forward voltage	$I_F = 2$ A	-	460	530	mV	
I_R	reverse current	$V_R = 60$ V	-	60	150	μ A	

[1] Device mounted on a ceramic Printed-Circuit Board (PCB), Al_2O_3 , standard footprint.

2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Graphic symbol
1	cathode	[1]	1  2
2	anode		<i>sym001</i>

[1] The marking bar indicates the cathode.

3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PMEG6020ER	-	plastic surface-mounted package; 2 leads	SOD123W

4. Marking

Table 4. Marking codes

Type number	Marking code
PMEG6020ER	BC

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_R	reverse voltage	$T_j = 25\text{ °C}$	-	60	V
$I_{F(AV)}$	average forward current	square wave; $\delta = 0.5$; $f = 20\text{ kHz}$			
		$T_{amb} \leq 75\text{ °C}$	[1] -	2	A
		$T_{sp} \leq 135\text{ °C}$	-	2	A
I_{FSM}	non-repetitive peak forward current	square wave; $t_p = 8\text{ ms}$	[2] -	50	A
P_{tot}	total power dissipation	$T_{amb} \leq 25\text{ °C}$	[3][4] -	0.57	W
			[3][5] -	0.95	W
			[3][1] -	1.8	W

Table 5. Limiting values ...continued*In accordance with the Absolute Maximum Rating System (IEC 60134).*

Symbol	Parameter	Conditions	Min	Max	Unit
T_j	junction temperature		-	150	°C
T_{amb}	ambient temperature		-55	+150	°C
T_{stg}	storage temperature		-65	+150	°C

[1] Device mounted on a ceramic PCB, Al_2O_3 , standard footprint.

[2] $T_j = 25$ °C prior to surge.

[3] Reflow soldering is the only recommended soldering method.

[4] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[5] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

6. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit	
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1][2]				
			[3]	-	-	220	K/W
			[4]	-	-	130	K/W
			[5]	-	-	70	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[6]	-	-	18	K/W

[1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.

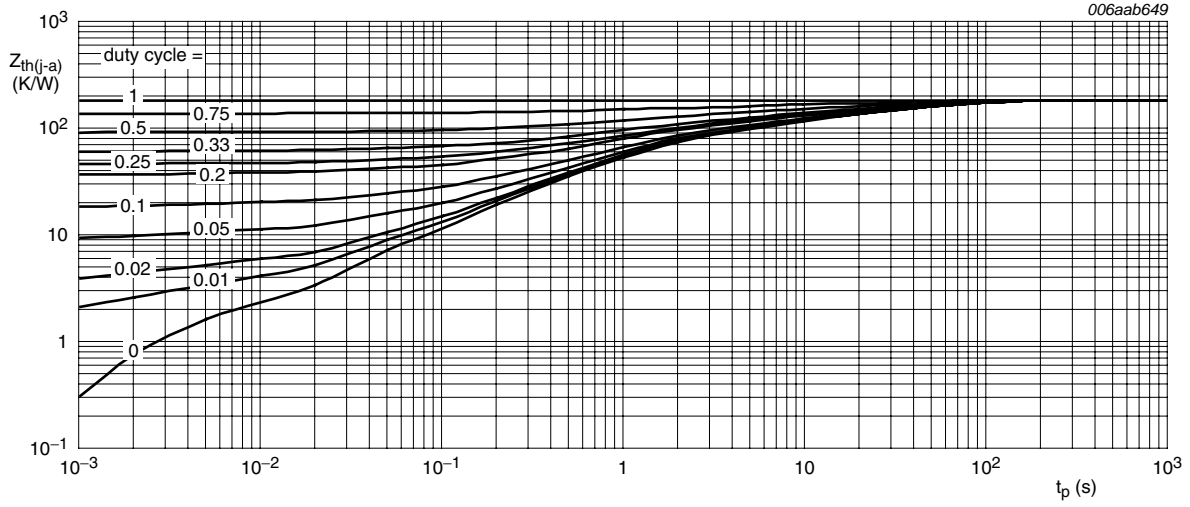
[2] Reflow soldering is the only recommended soldering method.

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[4] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

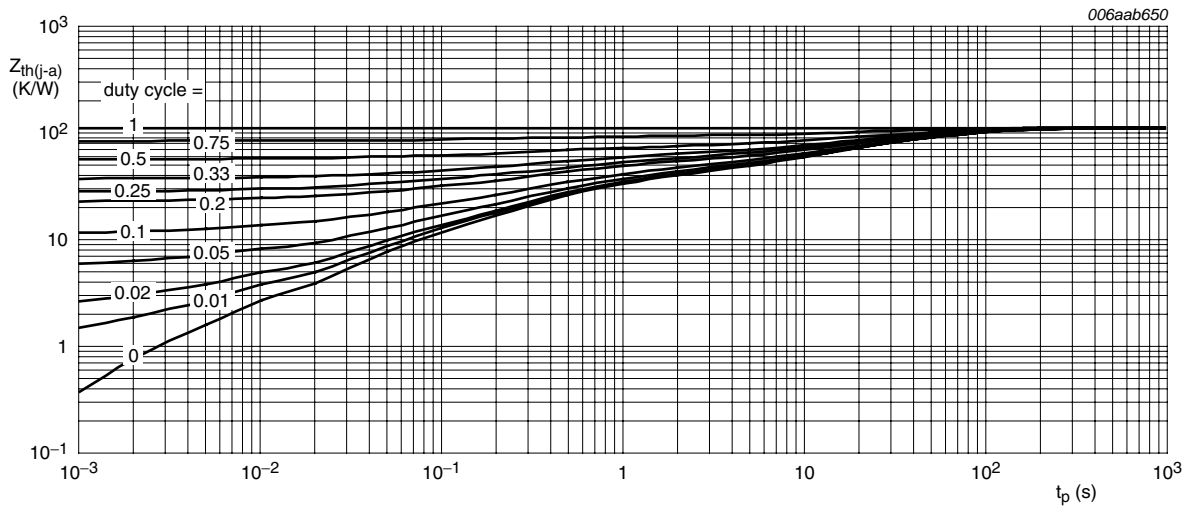
[5] Device mounted on a ceramic PCB, Al_2O_3 , standard footprint.

[6] Soldering point of cathode tab.



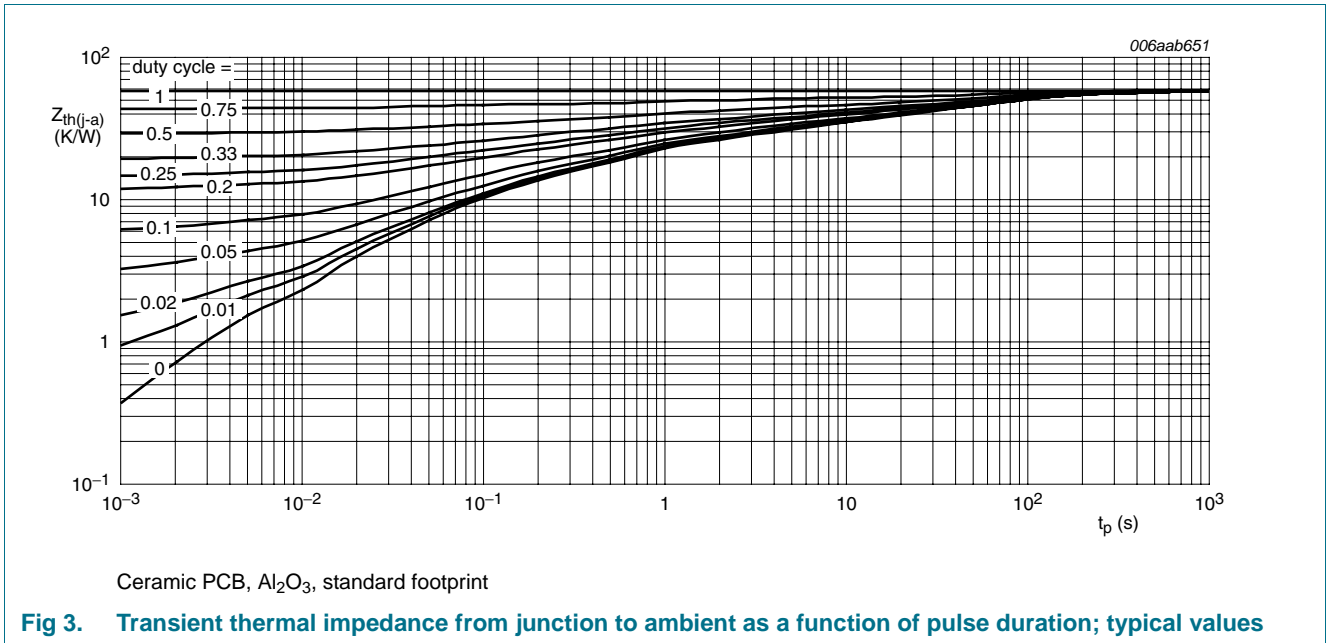
FR4 PCB, standard footprint

Fig 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for cathode 1 cm²

Fig 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

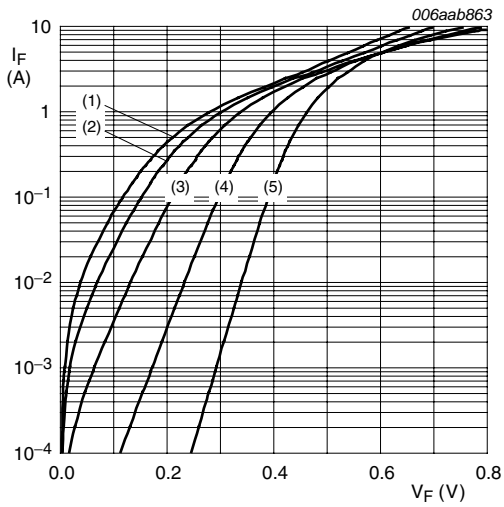


7. Characteristics

Table 7. Characteristics

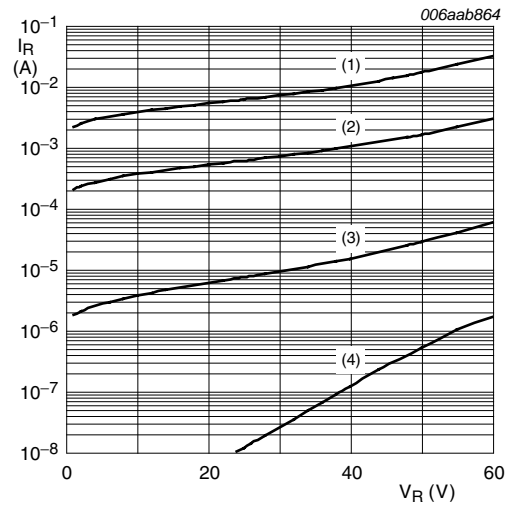
$T_j = 25\text{ °C}$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_F	forward voltage	$I_F = 0.1\text{ A}$	-	300	340	mV
		$I_F = 0.5\text{ A}$	-	360	420	mV
		$I_F = 1\text{ A}$	-	400	460	mV
		$I_F = 1.5\text{ A}$	-	430	500	mV
		$I_F = 2\text{ A}$	-	460	530	mV
I_R	reverse current	$V_R = 5\text{ V}$	-	2.5	-	μA
		$V_R = 10\text{ V}$	-	3.5	-	μA
		$V_R = 60\text{ V}$	-	60	150	μA
C_d	diode capacitance	$f = 1\text{ MHz}$				
		$V_R = 1\text{ V}$	-	240	-	pF
		$V_R = 10\text{ V}$	-	80	-	pF



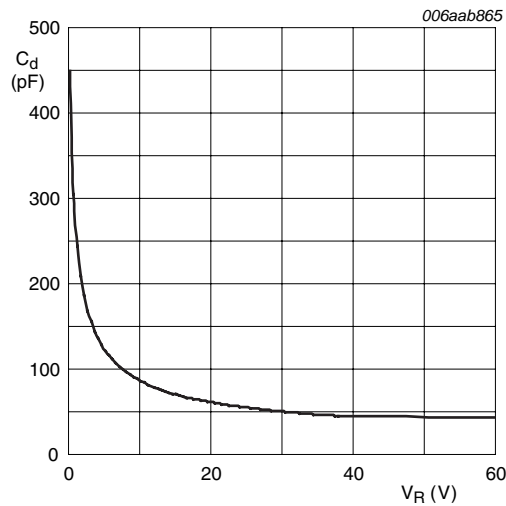
- (1) $T_j = 150^\circ\text{C}$
- (2) $T_j = 125^\circ\text{C}$
- (3) $T_j = 85^\circ\text{C}$
- (4) $T_j = 25^\circ\text{C}$
- (5) $T_j = -40^\circ\text{C}$

Fig 4. Forward current as a function of forward voltage; typical values



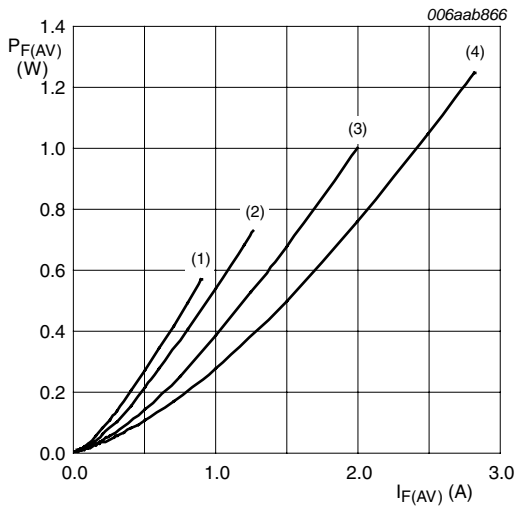
- (1) $T_j = 125^\circ\text{C}$
- (2) $T_j = 85^\circ\text{C}$
- (3) $T_j = 25^\circ\text{C}$
- (4) $T_j = -40^\circ\text{C}$

Fig 5. Reverse current as a function of reverse voltage; typical values



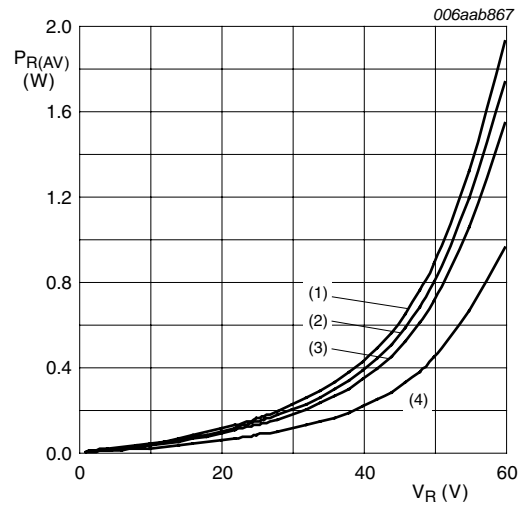
$f = 1\text{ MHz}; T_{\text{amb}} = 25^\circ\text{C}$

Fig 6. Diode capacitance as a function of reverse voltage; typical values



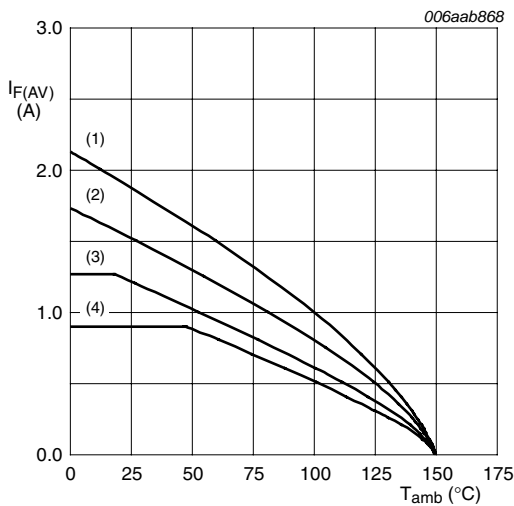
- $T_j = 150\text{ °C}$
- (1) $\delta = 0.1$
 - (2) $\delta = 0.2$
 - (3) $\delta = 0.5$
 - (4) $\delta = 1$

Fig 7. Average forward power dissipation as a function of average forward current; typical values



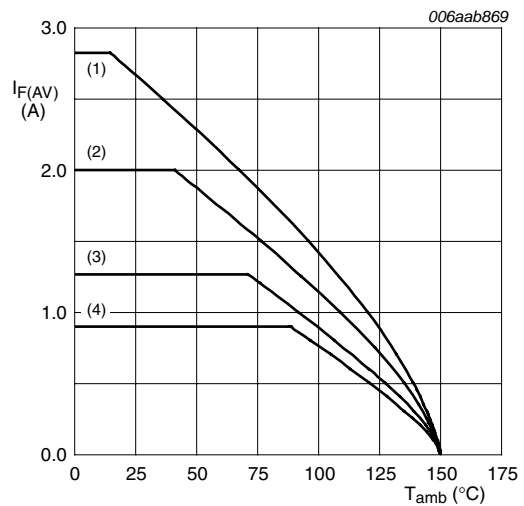
- $T_j = 125\text{ °C}$
- (1) $\delta = 1$
 - (2) $\delta = 0.9$
 - (3) $\delta = 0.8$
 - (4) $\delta = 0.5$

Fig 8. Average reverse power dissipation as a function of reverse voltage; typical values



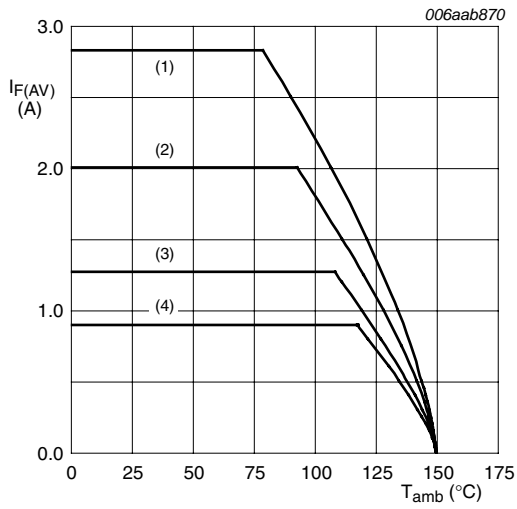
- FR4 PCB, standard footprint
 $T_j = 150\text{ °C}$
- (1) $\delta = 1$; DC
 - (2) $\delta = 0.5$; $f = 20\text{ kHz}$
 - (3) $\delta = 0.2$; $f = 20\text{ kHz}$
 - (4) $\delta = 0.1$; $f = 20\text{ kHz}$

Fig 9. Average forward current as a function of ambient temperature; typical values



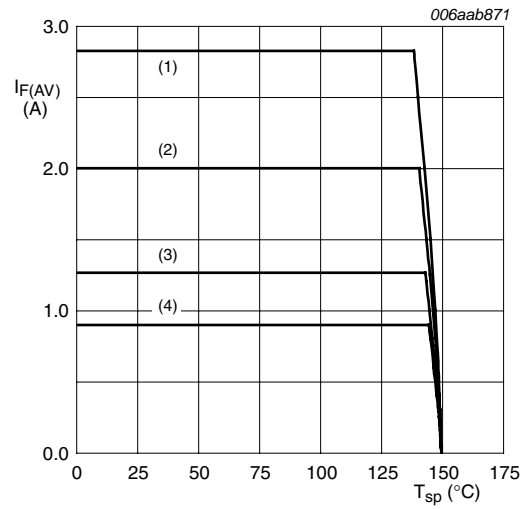
- FR4 PCB, mounting pad for cathode 1 cm^2
 $T_j = 150\text{ °C}$
- (1) $\delta = 1$; DC
 - (2) $\delta = 0.5$; $f = 20\text{ kHz}$
 - (3) $\delta = 0.2$; $f = 20\text{ kHz}$
 - (4) $\delta = 0.1$; $f = 20\text{ kHz}$

Fig 10. Average forward current as a function of ambient temperature; typical values



Ceramic PCB, Al_2O_3 , standard footprint
 $T_j = 150\text{ }^{\circ}C$
 (1) $\delta = 1$; DC
 (2) $\delta = 0.5$; $f = 20\text{ kHz}$
 (3) $\delta = 0.2$; $f = 20\text{ kHz}$
 (4) $\delta = 0.1$; $f = 20\text{ kHz}$

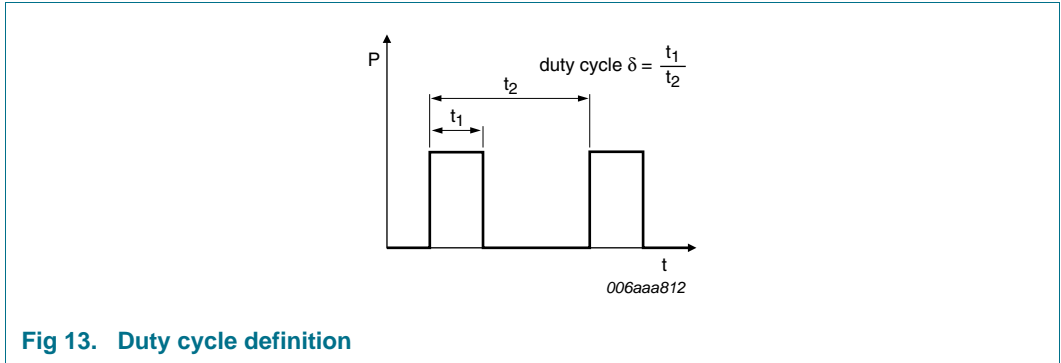
Fig 11. Average forward current as a function of ambient temperature; typical values



$T_j = 150\text{ }^{\circ}C$
 (1) $\delta = 1$; DC
 (2) $\delta = 0.5$; $f = 20\text{ kHz}$
 (3) $\delta = 0.2$; $f = 20\text{ kHz}$
 (4) $\delta = 0.1$; $f = 20\text{ kHz}$

Fig 12. Average forward current as a function of solder point temperature; typical values

8. Test information

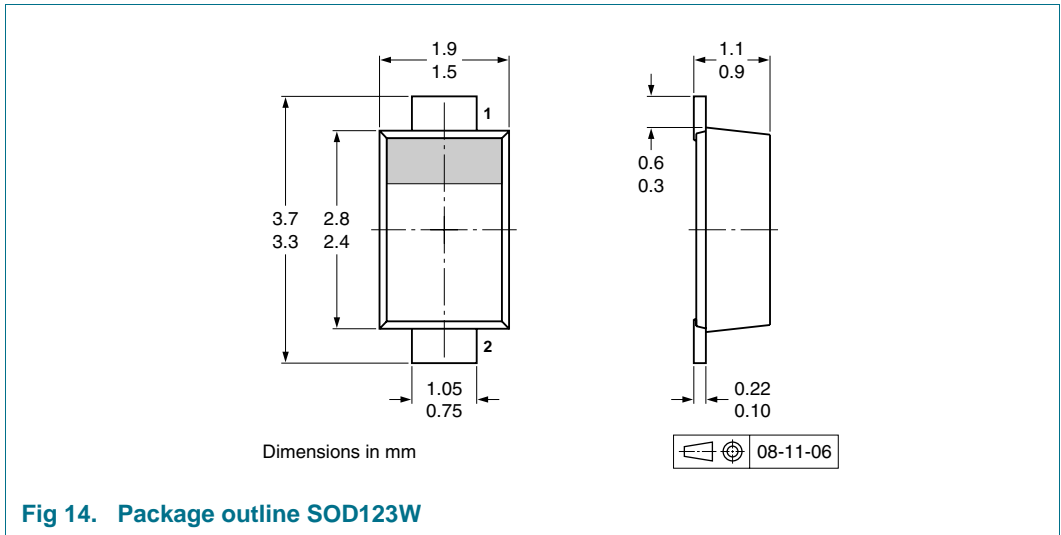


The current ratings for the typical waveforms as shown in [Figure 9](#), [10](#), [11](#) and [12](#) are calculated according to the equations: $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current, $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_M \times \sqrt{\delta}$ with I_{RMS} defined as RMS current.

8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

9. Package outline



10. Packing information

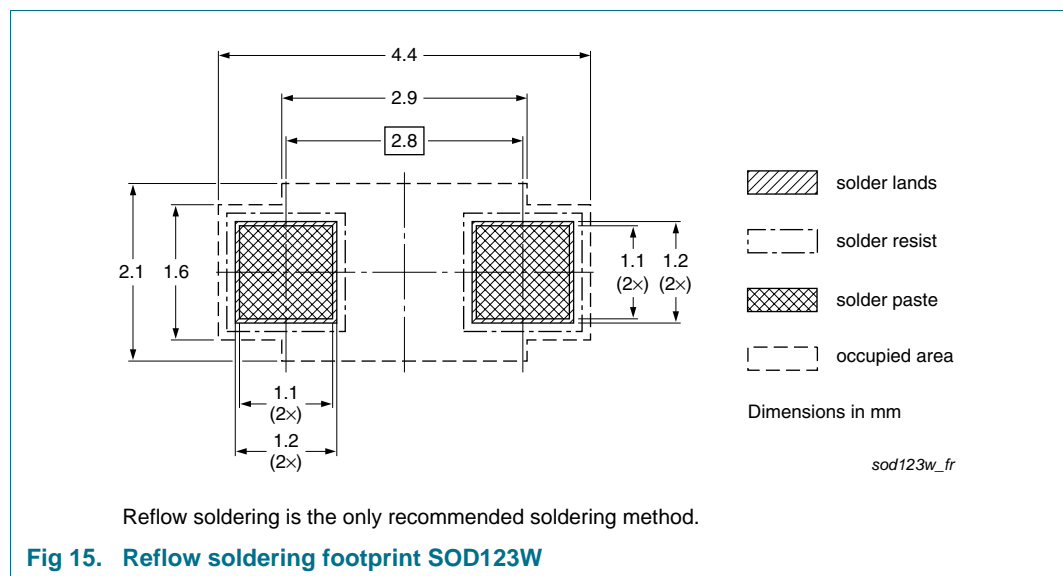
Table 8. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.^[1]

Type number	Package	Description	Packing quantity
			3000
PMEG6020ER	SOD123W	4 mm pitch, 8 mm tape and reel	-115

[1] For further information and the availability of packing methods, see [Section 14](#).

11. Soldering



12. Revision history

Table 9. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PMEG6020ER_1	20100303	Product data sheet	-	-

13. Legal information

13.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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